



Product Change Notification

Change Notification #: 117515 - 00
Change Title: Select Intel® SSD DC P4510 Series,
Intel® SSD DC P4610 Series
Intel® SSD D5-P4326 Series
Intel® SSD DC P4618 Series
Intel® SSD D5-P4420 Series,
PCN 117515-00, Product Material,
LTIM Update
Date of Publication: March 27, 2020

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	June 30, 2020
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Description of Change to the Customer:

The Intel® SSD DC P4510 Series, Intel® SSD DC P4610 Series, Intel® SSD D5-P4326 Series, Intel® SSD DC P4618 Series and Intel® SSD D5-P4420 Series SKUs listed in the Products Affected table below will have the following change:

- Adding LV Liquid Thermal Interface Material (LV LTIM) to replace current S35 LTIM

Customer Impact of Change and Recommended Action:

Intel anticipates no product impact with this change.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX010T801	959391
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX010T810	959392
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX020T801	959393
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX020T810	959394
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX040T801	959395
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX040T810	959396
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX080T801	959397
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX080T810	959398
Intel® SSD DC P4610 Series (7.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KE076T801	963520
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KE016T801	978083
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KE032T801	978084
Intel® SSD DC P4610 Series (6.4TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KE064T801	978085
Intel® SSD D5-P4326 Series (15.3TB, 2.5in PCIe 3.1 x4, 3D2, QLC) Generic Single Pack	SSDPE2NV153T801	979184
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KX010T8OS	984815
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KX010T8OP	984816
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KX020T8OS	984817
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KX020T8OP	984818
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KX040T8OS	984819
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KX040T8OP	984820
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KE016T8OS	984821
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KE016T8OP	984822
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KE032T8OS	984823
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KE032T8OP	984824
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDPE2KX080T8OS	986512
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDPE2KX080T8OP	986513

Marketing Name	Product Code	MM#
Intel® SSD DC P4618 Series (6.4TB, 1/2 Height PCIe 3.1 x8, 3D2, TLC) Generic Single Pack	SSDPECKE064T801	999CNK
Intel® SSD D5-P4420 Series (7.68TB, 2.5in, PCIe 3.1 x4, 3D2, QLC) Generic Single Pack	SSDPE2NU076T801	999DXN

PCN Revision History:

Date of Revision:

March 27, 2020

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

117515 - 00

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